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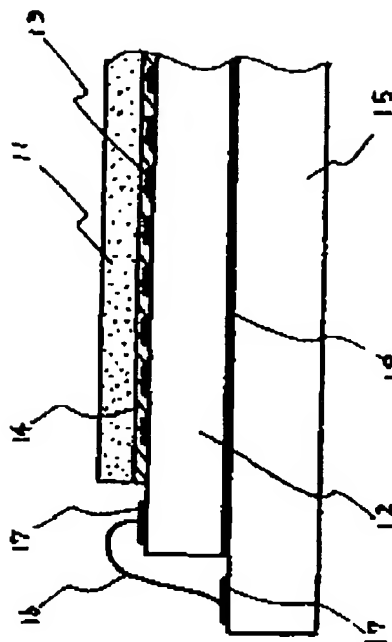
APPLICATION DATE : 12-03-85
APPLICATION NUMBER : 60048750

APPLICANT : SEIKO EPSON CORP;

INVENTOR : TAKESHITA TETSUYOSHI;

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TITLE : SOLID-STATE IMAGE PICKUP DEVICE



ABSTRACT : PURPOSE: To provide a mounting structure of a solid-state image pickup device having excellent damp-proof and environment-proof without forming a protective film, by bonding an insulating transparent substrate with the solid-state image pickup device face using adhesive.

CONSTITUTION: A solid-state image pickup device having more excellent damp- proof and environment-proof as compared with a prior art having a protective film such as an organic insulating film can be simply manufactured, since an insulating transparent substrate 11 is bonded with the solid-state image pickup device face 13 by adhesive so that the transparent substrate can serve as a protective layer for the solid-state image pickup device. Moreover, by using the transparent substrate also as a mounting substrate, a process for mounting the solid-state image pickup device and a process for forming the protective film can be done simultaneously, so that the manufacturing process can be considerably shortened and simplified. Accordingly, a solid-state image pickup device having excellent reliability can be provided at a low cost.

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